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TFT | CHARACTER | UWVD | FSC | SEGMENT | CUSTOM | REPLACEMENT

TFT Display Module

Part Number E50RG38048LW2M320-R

Overview:

- 5.0-inch TFT (120.7x75.8mm)
- 16/18/24-bit RGB Interface
- 800(RGB)x480 pixels
- 3.3V
- White LED back-light

- Transmissive/ Normally Black
- 4-wire Resistive Touch Screen
- 320 NITS
- Controller: ILI5960/ILI6122
- RoHS Compliant



Description

This is a color active matrix TFT (Thin Film Transistor) LCD (Liquid Crystal Display) that uses amorphous silicon TFT as a switching device. This model is composed of a Transmissive type TFT-LCD Panel, driver circuit and back-light unit. The resolution of a 5.0" TFT-LCD contains 800x480 pixels and can display up to 65K/262K/16.7M colors.

Features

Low Input Voltage: 3.3V (TYP) Display Colors of TFT LCD: 65K/262K/16.7M colors TFT Interface: 16/18/24-bit RGB

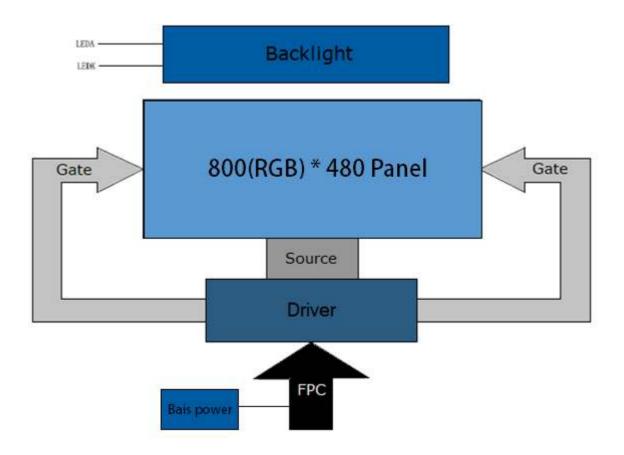
	Specification	Unit	Note
General Information Items	Main Panel		Note
TFT Display area (AA)	108.00(H) * 64.80(V) (5.0 inch)	mm	-
Driver element	TFT active matrix	-	-
Display colors	65K/262K/16.7M	colors	-
Number of pixels	800(RGB)*480	dots	-
TFT Pixel arrangement	RGB vertical stripe	-	-
Pixel pitch	0.108 (H) x 0.108 (V)	mm	-
Viewing angle	12:00	o'clock	-
TFT Controller IC	ILI5960/ILI6122	-	-
Display mode	Transmissive/ Normally White	-	-
Operating temperature	-20~+70	°C	-
Storage temperature	-30~+80	°C	-

Mechanical Information

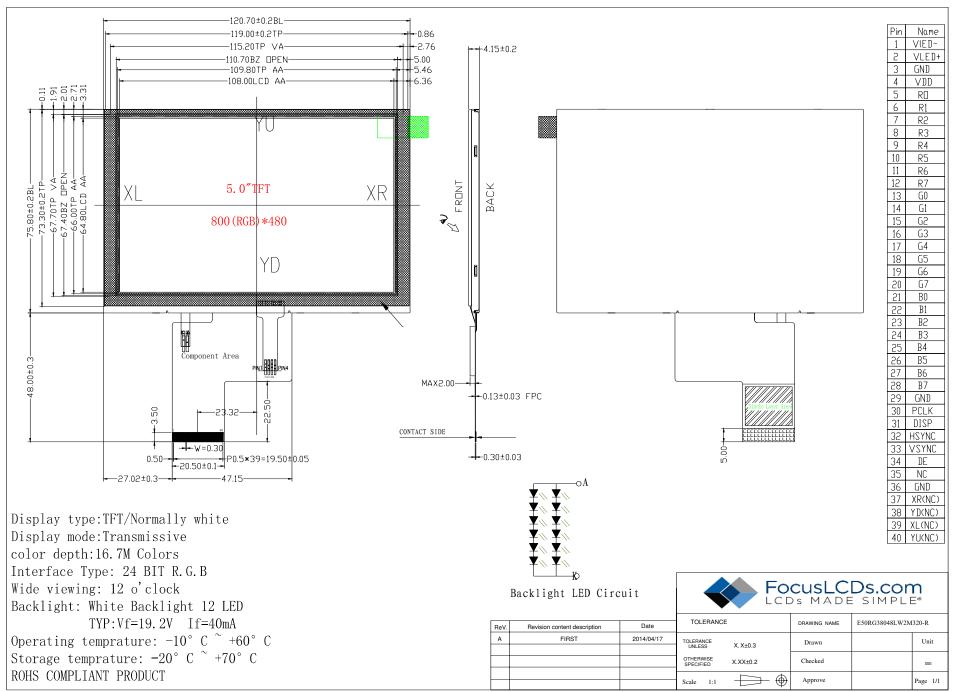
Item		Min	Тур.	Max	Unit	Note
	Horizontal(H)		120.70		mm	-
Module size	Vertical(V)		75.80		mm	-
Depth(D)			4.15		mm	-
Weight			TBD		g	-



1. Block Diagram



2. Outline dimensions





3. Input Terminal Pin Assignment

NO.	Symbol	Description	I/O
1	VLED-	Cathode pin of backlight	P
2	VLED+	Anode pin of backlight	P
3	GND	Ground	P
4	VDD	Supply voltage (3.3V)	Р
5	R0	Red data input	I/O
6	R1	Red data input	I/O
7	R2	Red data input	I/O
8	R3	Red data input	I/O
9	R4	Red data input	I/O
10	R5	Red data input	I/O
11	R6	Red data input	I/O
12	R7	Red data input	I/O
13	G0	Green data input	I/O
14	G1	Green data input	I/O
15	G2	Green data input	I/O
16	G3	Green data input	I/O
17	G4	Green data input	I/O
18	G5	Green data input	I/O
19	G6	Green data input	I/O
20	G7	Green data input	I/O
21	B0	Blue data input	I/O
22	B1	Blue data input	I/O
23	B2	Blue data input	I/O
24	B3	Blue data input	I/O
25	B4	Blue data input	I/O
26	B5	Blue data input	I/O
27	B6	Blue data input	I/O
28	B7	Blue data input	I/O
29	GND	Ground	Р
30	PCLK	Dot clock signal for RGB interface operation. Fix this pin to VCI or GND when not used.	I
31	DISP	Standby setting for testing. Should be connected to VDDIO in normal operation mode. If connected to GND the IC is in standby mode.	I
32	HSYNC	Line synchronizing signal for RGB interface operation. Fix to VCI or GND when not in use.	I
33	VSYNC	Frame synchronizing signal for RGB interface operation. Fix this pin to VCI or GND when not used.	I
34	DE	Data enable signal for RGB interface operation. Fix to VCI or GND when not used.	I
35	NC	NC	
36	GND	Ground	Р
37	XR(NC)	Touch panel right glass terminal	A/D
38	YD(NC)	Touch panel bottom film terminal	A/D
39	XL(NC)	Touch panel left glass terminal	A/D
40	YU(NC)	Touch panel top film terminal	A/D



4. LCD Optical Characteristics

4.1 Optical Specifications

ltem		Symbol	Condition	Min	Тур.	Max	Unit	Note
Contrast	Ratio	CR		560	700			(2)
	Rising	TR			4	8	msec	(4)
Response time	Falling	TF			12	24	msee	(4)
Transmitt (with pola		T(%)			4.29		%	(3)
Transmitt (without po		T(%)			12.16		%	(3)
Color Ga	mut	S(%)	$\Theta = \Phi = 0$		62		%	(5)
	$\frac{1}{White} \frac{W_x}{W_x}$ Normal				0.303	0.323		
	vvince	W _Y	viewing angle	0.305	0.325	0.345		
	Red R _x	R _x		0.606	0.626	0.646		
Color Filter		R _Y		0.314	0.334	0.354		
Chromaticity	Green	G _x		0.257	0.277	0.297		(5)(6)
		Gy		0.529	0.549	0.569		
	Blue	B _x		0.122	0.142	0.162		
	Dide	By		0.102	0.122	0.142		
	Hor.	ΘL		60	70			
Viewing angle		ΘR	Cr>10	60	70			
	Ver.	ΘU	Cn/10	60	70			(1)(6)
		ΘD		40	60			
Option View Direction 12 o'clock								(1)

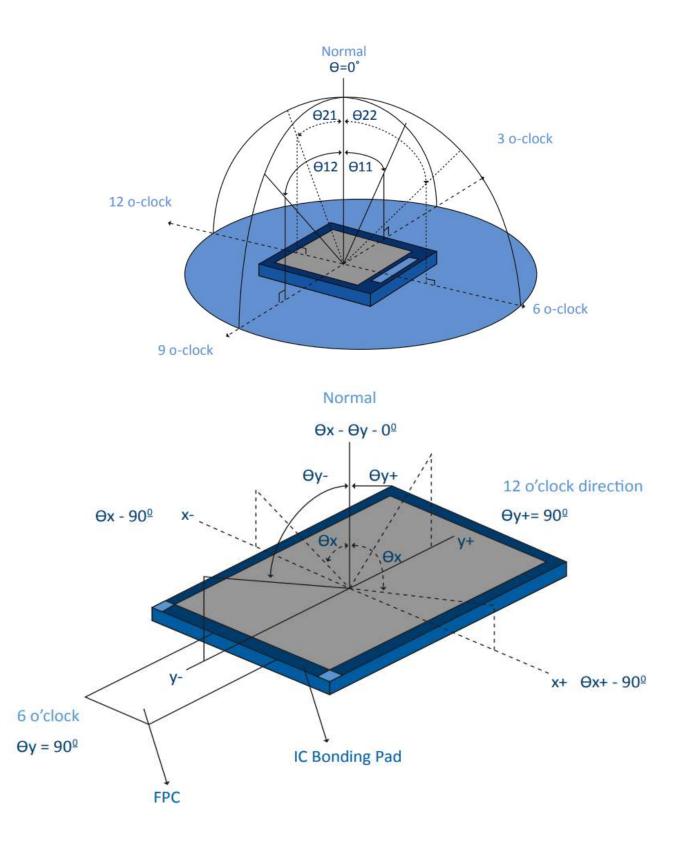
4.2 Measuring Condition

VDD = 3.3V, IL = 20mA (Backlight current) Ambient temperature: 25 ± 2°C 15min. warm-up time



Optical Specification Reference Notes:

(1) Definition of Viewing Angle: The viewing angle is the angle at which the contrast ratio is greater than 10. The viewing angles are determined for the horizontal or 3,9 o'clock direction and the vertical or 6,12 o'clock direction with respect to the optical axis which is normal to the LCD surface.

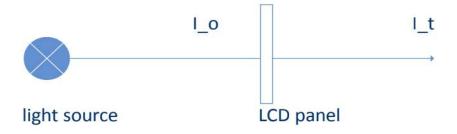




(2) Definition of Contrast Ratio (Cr): measured at the center point of panel. The contrast ratio (Cr) measured on a module, is the ratio between the luminance (Lw) in a full white area (R=G=B=1) and the luminance (Ld) in a dark area (R=G=B=0).

$$Cr = \frac{Lw}{Ld}$$

(3) Definition of transmittance (T%): The transmittance of the panel including the polarizers is measured with electrical driving.

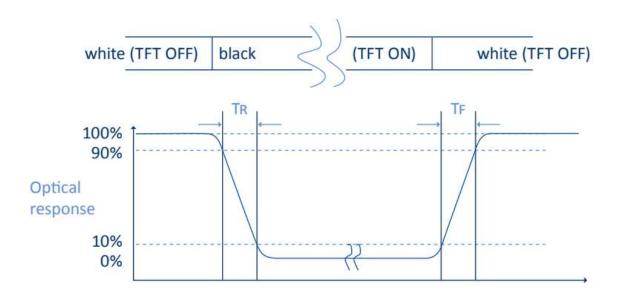


The transmittance is defined as:

$$Tr = \frac{It}{Io} x \ 100\%$$

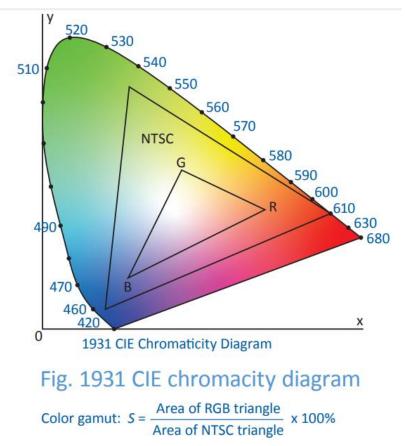
Io = the brightness of the light source. It = the brightness after panel transmission

(4) Definition of Response Time (Tr, Tf): The rise time 'Tr' is defined as the time for luminance to change from 90% to 10% as a result of a change of the electrical condition. The fall time 'Tf' is defined as the time for luminance to change from 10% to 90% as a result of a change of the electrical condition.

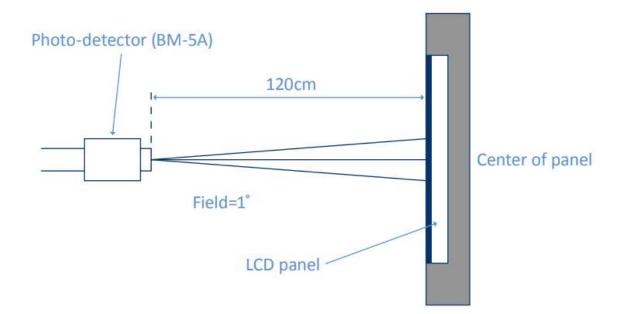




(5) Definition of Color Gamut: Measuring machine CFT-01. NTSC's Primaries: R(x,y,Y),G(x,y,Y), B(x,y,Y). FPM520 of Westar Display Technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics. The color chromaticity shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the panel.



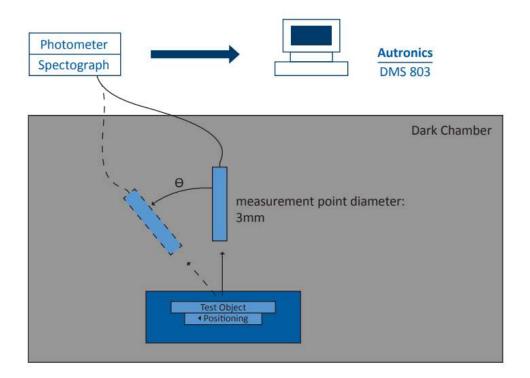
(6) Definition of Optical Measurement Setup:



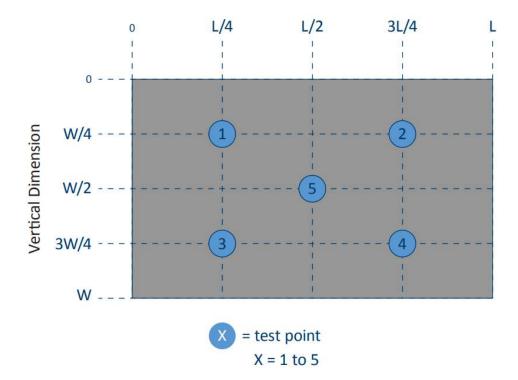


(6) Optical Measurement Setup Continued:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 20 minutes.



Horizontal Dimension





5. Electrical Characteristics

5.1 Absolute Maximum Rating (Ta=25 VSS=0V)

Characteristics	Symbol	Min	Max	Unit
Digital Supply Voltage	VDD	-0.5	5.0	V
Digital Interface Supply Voltage	VDDIO	-0.5	VDD+0.3	v
Operating temperature	T _{OP}	-20	+70	°C
Storage temperature	Tst	-30	+80	°C

NOTE: If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

5.2 DC Electrical Characteristics

Characteristics	Symbol	Min.	Тур.	Max.	Unit	Note
Digital Supply Voltage	VDD	3.0	3.3	4.2	V	
Digital Interface Supply Voltage	VDDIO	3.0	3.3	4.2	V	
Normal Mode Current Consumption	IDD		200		mA	
Level input voltage	VIH	0.7 VDDIO		VDDIO	V	
	VIL	GND		0.3 VDDIO	V	
Level output voltage	VOH	0.8 VDDIO		VDDIO	V	
Level output voltage	VOL	GND		0.2 VDDIO	V	



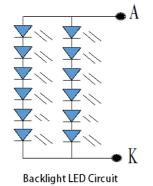
5.3 LED Backlight Characteristics

ltem	Symbol	Min	Тур.	Max	Unit	Note
Forward Current	IF	30	40		mA	
Forward Voltage	VF		19.2		V	
LCM Luminance	LV	320			cd/m2	Note 3
LED lifetime	Hr	50000			hour	Note1 & 2
Uniformity	AVg	80			%	Note 3

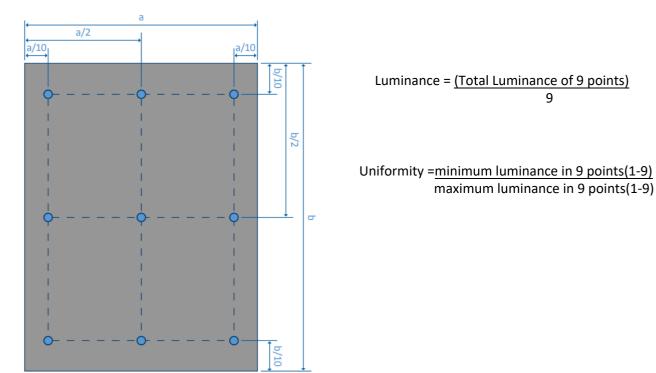
The back-light system is edge-lighting type with 12 chips White LED

Note 1: LED lifetime (Hr) can be defined as the time in which it continues to operate under the condition: Ta=25±3 °C, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note 2: The "LED lifetime" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and IL=40mA. The LED lifetime could be decreased if operating IL is larger than 40mA. The constant current driving method is suggested.



Note 3: Luminance Uniformity of these 9 points is defined as below:





6. AC Characteristics

6.1 AC Timing Characteristics

Parameter	Symbol	Min	Тур.	Max	Unit	Conditions
VDD Power ON slew rate	t por			20	ms	0V-0.9VDD
RSTB pulse width	trst	10			us	CLKIN=50MHz
CLKIN cycle time	tсрн	20			ns	
CLKIN pulse duty	tсwн	40	50	60	%	
VSD setup time	t vst	8			ns	
VSD hold time	t vhd	8			ns	
HSD setup time	tнsт	8			ns	
HSD hold time	tннd	8			ns	
Data setup time	t dst	8			ns	D0[7:0], D1[7:0], D2[7:0] to CLKIN
Data hold time	t dhd	8			ns	D0[7:0], D1[7:0], D2[7:0] to CLKIN
DE setup time	t est	8			ns	
DE hold time	t ehd	8			ns	
Output stable time	t ss⊤			6	us	10% to 90% target voltage,
						CL=120pF, R=10kΩ
CLKIN frequency	fськ		40	50	MHz	VDD=3.0-3.6V
CLKIN cycle time	tclk	20	25		ns	
CLKIN pulse duty	tсwн	40	50	6	%	Tclk
Time from HSD to Source output	tнso		20		CLKIN	
Time from HSD to LD	thld		20		CLKIN	
Time from HSD to STV	t HSTV		2		CLKIN	
Time from HSD toCKV	tнскv		20		CLKIN	
Time from HSD to OEV	t hoev		4		CLKIN	
LD pulse width	twld		10		CLKIN	
CKV pulse width	twcкv		66		CLKIN	
OEV pulse width	twoev		74		CLKIN	

Table 6.1: AC Timing Characteristics Table

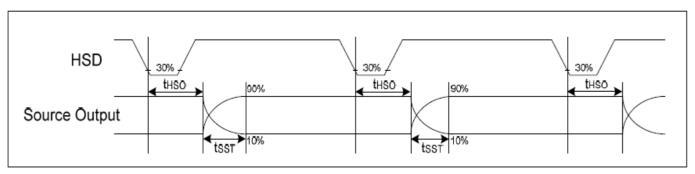


Figure 6.1: Source Output Timing Diagram (Cascade)



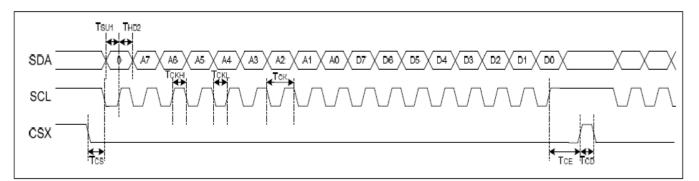


Figure 6. 2: SPI Timing Diagram

Parameter	Symbol	Min	Тур.	Max	Unit	Condition
SCL period	Tclk	60			ns	
SCL high width	Тскн	30			ns	
SCL low width	Тскг	30			ns	
Data setup time	Tsui	12			ns	
Data hold time	Thd1	12			ns	
CSX to SCL setup time	Tcs	20			ns	
CSX to SDA hold time	TCE	20			ns	
CSX high pulse width	Тср	50			ns	

Table 6.2: SPI AC Timing Characteristics Table

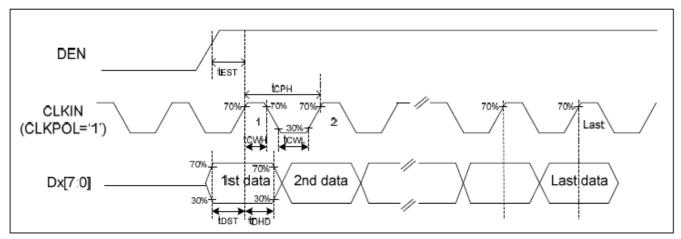


Figure 6.3: DE Mode (Mode='1') Timing Diagram

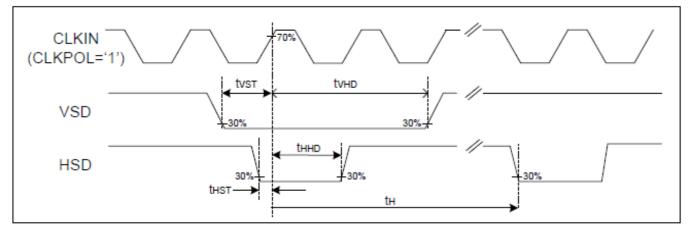


Figure 6.4: SYNC Mode (Mode='0') Timing Diagram



6.2 Display Timing Characteristics

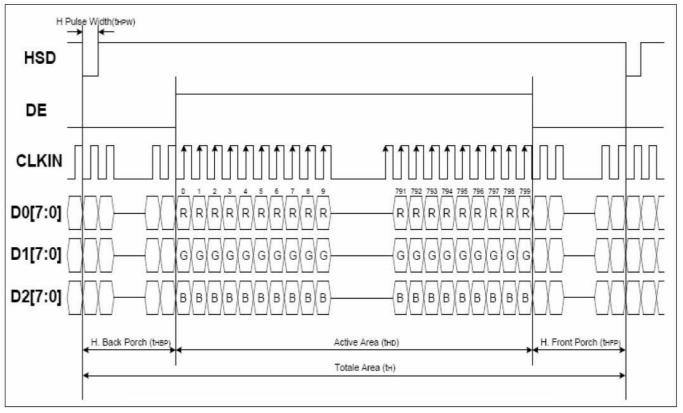


Figure 6.5: Horizontal Input Timing Diagram

Parameter	rs	Symbol	Min	Тур.	Max	Unit	Condition		
Horizontal display area		tнd		800		DCLK			
DCLK frequency		fclk		33.3	50	MHz			
1 Horizontal line period		th	862	1056	1200	DCLK			
	Min			1		DCLK			
HSD pulse width	Тур.	thpw				DCLK			
	Max			40		DCLK			
HSD back porch	Sync	tнвр	46	46	46	DCLK			
HSD front porch	Sync	thfp	16	210	354	DCLK			

Horizontal Input Timing

Table 6.3: Horizontal Input Timing Characteristics



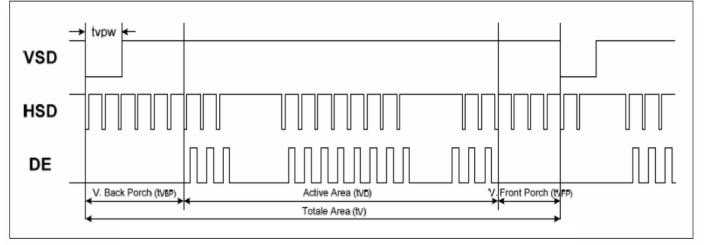


Figure 6.6: Vertical Input Timing Diagram

Vertical Input Timing

Parameters	Symbol	Min	Тур.	Max	Unit	Condition
Vertical display area	tvd		480		HSD	
VSD period time	fv	510	525	650	HSD	
VSD pulse width	tvpw	1		20	HSD	
VSD back porch	tvвр	23	23	23	HSD	
VSD front porch	tvfp	7	22	147	HSD	

Table 6.4: Vertical Input Timing Characteristics



7. Cautions and Handling Precautions

7.1 Handling and Operating the Module

- 1. When the module is assembled, it should be attached to the system firmly. Do not warp or twist the module during assembly work.
- 2. Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- 3. Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
- 4. Do not allow drops of water or chemicals to remain on the display surface. If you have the droplets for a long time, staining and discoloration may occur.
- 5. If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
- 6. The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane. Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
- 7. If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
- 8. Protect the module from static; it may cause damage to the CMOS ICs.
- 9. Use fingerstalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- 10. Do not disassemble the module.
- 11. Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- 12. Pins of I/F connector shall not be touched directly with bare hands.
- 13. Do not connect, disconnect the module in the "Power ON" condition.
- 14. Power supply should always be turned on/off by the item Power On Sequence & Power Off Sequence.

7.2 Storage and Transportation

- 1. Do not leave the panel in high temperature, and high humidity for a long time. It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%
- 2. Do not store the TFT-LCD module in direct sunlight.
- 3. The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
- 4. It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module. In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.
- 5. This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.